

LC020 Single-Output Series Power Module: 18 Vdc to 36 Vdc Inputs; 20 W



The LC020 Single-Output Series Power Module uses advanced, surface-mount technology and delivers high-quality, compact, dc-dc conversion at an economical price.

Features

- Low profile: 9.9 mm (0.390 in.) with standoffs, 9.53 mm (0.375 in.) with standoffs recessed
- Wide input voltage range: 18 Vdc to 36 Vdc
- Output current limiting, unlimited duration
- Short-circuit protection
- Output overvoltage clamp
- Input-to-output isolation: 850 V
- Operating ambient temperature range: -40 °C to +100 °C
- Remote on/off
- Output voltage adjust: 90% to 110% of Vo, nom
- UL* 1950 Recognized, CSA[†] 22.2-234 Certified, IEC950, EN60950, and VDE0805 Licensed
- Within FCC and VDE Class A radiated limits

Options

- Choice of on/off configuration
- Case ground pin
- Synchronization
- Short pin: 2.79 mm ± 0.25 mm (0.110 in. ± 0.010 in.)

Description

The LC020 Single-Output Series Power Modules are low-profile, dc-dc converters that operate over an input voltage range of 18 Vdc to 36 Vdc and provide a precisely regulated 3.3 V, 5 V, 12 V, or 15 V output. The output is isolated from the input, allowing versatile polarity configurations and grounding connections. The modules have a maximum power rating of 20 W at a typical full-load efficiency of up to 85%.

The power module features remote on/off and output voltage adjustment of 90% to 110% of the nominal output voltage. Built-in filtering for both input and output minimizes the need for external filtering.

* *UL* is a registered trademark of Underwriters Laboratories, Inc.

† CSA is a registered trademark of Canadian Standards Association.

Absolute Maximum Ratings

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. These are absolute stress ratings only. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operations sections of the data sheet. Exposure to absolute maximum ratings for extended periods can adversely affect device reliability.

Parameter	Symbol	Min	Max	Unit
Input Voltage				
Continuous	Vı	0	40	Vdc
100 ms Transient	Vı	0	50	V
Operating Case Temperature	Tc	-4 0	100	°C
Storage Temperature	Tstg	-4 0	120	°C
I/O Isolation Voltage	_	_	850	Vdc

Electrical Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions.

Table 1. Input Specifications

Parameter	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	Vı	18	28	36	Vdc
Maximum Input Current (See Figure 1.) (VI = 0 V to VI, max; Io = Io, max)	II, max	_	_	2.2	Α
Inrush Transient	i ² t	_	_	0.1	A ² s
Input Reflected-ripple Current (50 Hz to 20 MHz; 12 μH source impedance, Tc = 25 °C; see Figure 7.)	lı		3	_	mAp-p
Input Ripple Rejection (100 Hz—120 Hz)	-		60	_	dB

Fusing Considerations

CAUTION: This power module is not internally fused. An input line fuse must always be used.

This encapsulated power module can be used in a wide variety of applications, ranging from simple stand-alone operation to an integrated part of a sophisticated power architecture. To preserve maximum flexibility, internal fusing is not included; however, to achieve maximum safety and system protection, always use an input line fuse. The safety agencies require a normal-blow, dc fuse with a maximum rating of 5 A (see Safety Considerations section). Based on the information provided in this data sheet on inrush energy and maximum dc input current, the same type of fuse with a lower rating can be used. Refer to the fuse manufacturer's data for further information.

Electrical Specifications (continued)

Table 2. Output Specifications

Parameter	Device	Symbol	Min	Тур	Max	Unit
Output Voltage	LC020A	Vo	4.80	_	5.20	Vdc
(Over all line, load, and temperature	LC020B	Vo	11.52	_	12.48	Vdc
conditions until end of life; see Figure 9.)	LC020C	Vo	14.40		15.60	Vdc
	LC020F	Vo	3.17	_	3.43	Vdc
Output Voltage Set Point	LC020A	VO, set	4.92	_	5.08	Vdc
$(V_1 = 28 \text{ V}; I_0 = I_0, max; T_c = 25 ^{\circ}C)$	LC020B	Vo, set	11.81		12.19	Vdc
	LC020C	Vo, set	14.76	_	15.24	Vdc
	LC020F	Vo, set	3.25		3.35	Vdc
Output Regulation:						
Line (Vi = 18 V to 36 V)	All			0.01	0.1	% V o
Load (lo = lo, min to lo, max)	All			0.05	0.2	% V o
Temperature (Tc = -40 °C to $+100$ °C)	All	_	_	0.5	1.0	%Vo
Output Ripple and Noise (See Figure 8.)						
RMS	LC020A, F	_	<u> </u>	_	20	mVrms
	LC020B, C	_		_	50	mVrms
Peak-to-peak (5 Hz to 20 MHz)	LC020A, F	_	-	20	100	mVp-p
	LC020B, C	_		50	150	mVp-p
Output Current	LC020A, F	lo	0.4		4.0	Α
(At lo < lo, min, the modules may exceed	LC020B	lo	0.17	_	1.67	Α
output ripple specifications.)	LC020C	lo	0.13	_	1.33	Α
Output Current-limit Inception	All	lo	103	_	150	%lo, max
(Vo = 90% x Vo, set) (See Figure 2.)						•
Output Short-circuit Current	All	lo	_	135	200	%lo, max
(Vo = 250 mV)						
Efficiency (VI, nom; IO = IO, max; TC = 25 °C;	LC020A	η	76	79	_	%
see Figures 3 and 9.)	LC020B	ή	79	82	_	%
	LC020C	ή	79	82	_	%
	LC020F	η	73	76	_	%
Dynamic Response						
$(\Delta Io/\Delta t = 1 A/10 \mu s, V_i = V_i, nom,$,	
T _A = 25 °C):						
Load Change from $lo = 50\%$ to 75% of						
IO, max:						
Peak Deviation	All		_	1	_	%Vo, set
Settling Time (Vo < 10% peak deviation)	All			0.5		ms
Load Change from Io = 50% to 25% of						-
IO, max:						
Peak Deviation	All	_	_	1		%Vo, set
Settling Time (Vo < 10% peak deviation)	All		_	0.5		ms

Table 3. Isolation Specifications

Parameter	Min	Тур	Max	Unit
Isolation Capacitance	_	0.002	_	μF
Isolation Resistance	10	_	_	MΩ

General Specifications

Parameter	Min	Тур	Max	Unit
Calculated MTBF (Io = 80% of Io, max; Tc = 40 °C)		5,800,000		
Weight		_	54 (1.9)	g (oz.)

Feature Specifications

Unless otherwise indicated, specifications apply over all operating input voltage, resistive load, and temperature conditions. See Feature Descriptions and Design Considerations for further information.

Parameter	Device	Symbol	Min	Тур	Max	Unit
Remote On/Off	-					
(V _I = 0 V to 36 V; open collector or equivalent						
compatible; signal referenced to V _I (–) terminal.						
See Figure 10 and Feature Descriptions.):		[
LC020xx Positive Logic				İ		
Logic Low—Module Off					İ	
Logic High—Module On						}
LC020xx1 Negative Logic			ļ			ļ
Logic LowModule On					ŀ	
Logic High—Module Off				İ	ļ	
Module Specifications:			İ			Ì
On/Off Current—Logic Low	All	lon/off	—	l —	1.0	mA
On/Off Voltage:						
Logic Low	All	Von/off	0	-	1.2	V
Logic High (lon/off = 0)	All	Von/off	<u> </u>	_	6	V
Open Collector Switch Specifications:		İ				
Leakage Current During Logic High	All	lon/off	l —	 	50	μΑ
(Von/off = 6 V)						
Output Low Voltage During Logic Low	All	Von/off	_	 	1.2	V
(lon/off = 1 mA)						:
Turn-on Time (Io = 80% of Io, max;	All				2	ms
Tc = 40 °C Vo within \pm 1% of steady state)						
Output Voltage Overshoot	All	_	 	0	5.0	%
Output Voltage Set-Point Adjustment Range	All	_	90	_	110	%Vo, nom
Output Overvoltage Clamp	LC020A	VO, clamp	5.6	—	7.0	V
	LC020B	Vo, clamp	13.2	_	16.5	V
	LC020C	VO, clamp	16.5	_	19.0	v
	LC020F	VO, clamp	3.9	<u> </u>	5.0	V

Characteristics Curves

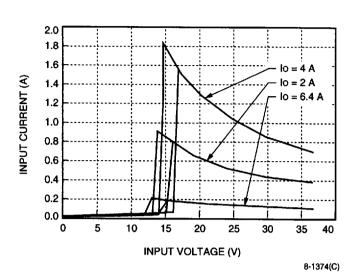


Figure 1. LC020A Typical Input Characteristics, $T_A = 25 \, ^{\circ}C$

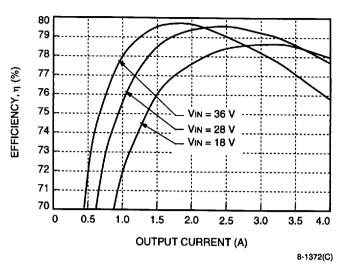


Figure 3. LC020A Typical Converter Efficiency vs. Output Current, $T_A = 25$ °C

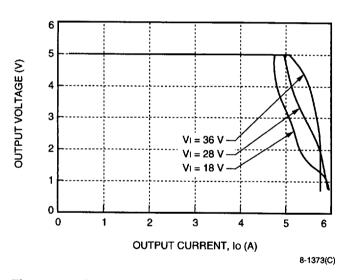


Figure 2. LC020A Typical Output Characteristics, $T_A = 25 \, ^{\circ}C$

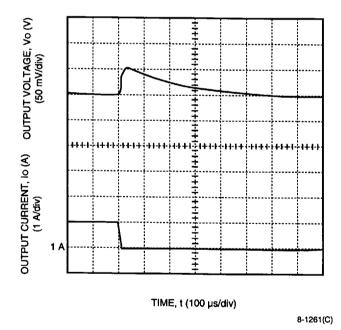
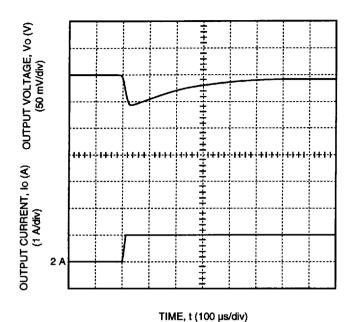


Figure 4. LC020A Typical Output Voltage for a Step Load Change from 50% to 25%

Characteristics Curves (continued)



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Figure 5. LC020A Typical Output Voltage for a Step Load Change from 50% to 75%

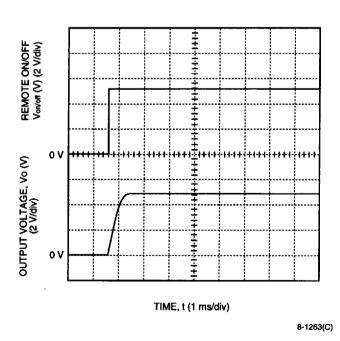
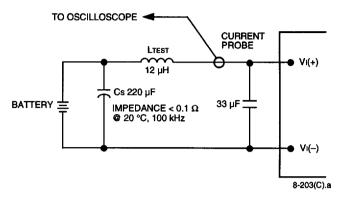


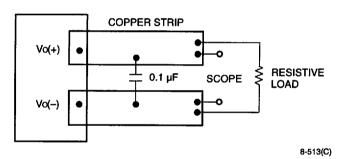
Figure 6. LC020A Typical Output Voltage Start-Up
When Signal Applied to Remote On/Off

Test Configurations



Note: Input reflected-ripple current is measured with a simulated source impedance of 12 μ H. Capacitor Cs offsets possible battery impedance. Current is measured at the input of the module.

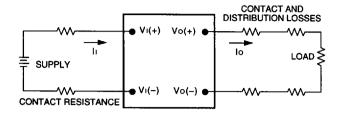
Figure 7. Input Reflected-Ripple Test Setup



Note: Use a 0.1 μF ceramic capacitor. Scope measurement should be made using a BNC socket. Position the load between 50 mm (2 in.) and 75 mm (3 in.) from the module.

Figure 8. Peak-to-Peak Output Noise Measurement Test Setup

Test Configurations (continued)



Note: All measurements are taken at the module terminals. When socketing, place Kelvin connections at module terminals to avoid measurement errors due to socket contact resistance.

$$\eta = \left(\frac{[Vo(+) - Vo(-)]Io}{[VI(+) - VI(-)]II}\right) \times 100$$

Figure 9. Output Voltage and Efficiency Measurement Test Setup

Design Considerations

Input Source Impedance

The power module should be connected to a low acimpedance input source. Highly inductive source impedances can affect the stability of the power module. For the test configuration in Figure 7, a 33 μF electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the power module helps ensure stability of the unit. For other highly inductive source impedances, consult the factory for further application guidelines.

Metal Case Connection

For standard units, the case is connected internally to V_I(-). For units with the case ground pin option, the case is not connected internally allowing the user flexibility in grounding.

Safety Considerations

For safety-agency approval of the system in which the power module is used, the power module must be installed in compliance with the spacing and separation requirements of the end-use safety agency standard, i.e., *UL*-1950, *CSA* 22.2-950, EN60950.

For the converter output to be considered meeting the requirements of safety extra low voltage (SELV), the input must meet SELV requirements.

If the input meets extra low voltage (ELV) requirements, then the converter's output is considered ELV.

The input to these units are to be provided with a maximum 5 A normal-blow fuse in the ungrounded lead.

Feature Descriptions

Output Overvoltage Clamp

The output overvoltage clamp consists of control circuitry, independent of the primary regulation loop, that monitors the voltage on the output terminals. The control loop of the shutdown has a higher voltage set point than the primary loop (see Feature Specifications table).

In a fault condition, the overvoltage clamp ensures that the output voltage does not exceed Vo, clamp, max. This provides a redundant voltage control that reduces the risk of output overvoltage.

Current Limit

To provide protection in a fault (output overload) condition, the unit is equipped with internal current-limiting circuitry and can endure current limiting for an unlimited duration. At the point of current-limit inception, the unit shifts from voltage control to current control. If the output voltage is pulled very low during a severe fault, the current-limit circuit can exhibit either foldback or tailout characteristics (output-current decrease or increase). The unit operates normally once the output current is brought back into its specified range.

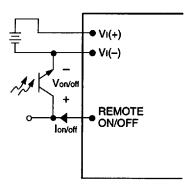
Feature Descriptions (continued)

Remote On/Off

Two remote on/off options are available. Positive logic remote on/off turns the module on during a logic high voltage on the remote on/off pin, and off during a logic low. Negative logic (code suffix of 1) remote on/off turns the module off during a logic high and on during a logic low.

To turn the power module on and off, the user must supply a switch to control the voltage between the on/off terminal and the V_I(–) terminal (Von/off). The switch can be an open collector or equivalent (see Figure 10). A logic low is Von/off = 0 V to 1.2 V. The maximum lon/off during a logic low is 1 mA. The switch should maintain a logic low voltage while sinking 1 mA.

During a logic high, the maximum $V_{on/off}$ generated by the power module is 6 V. The maximum allowable leakage current of the switch at $V_{on/off} = 6$ V is 50 μ A.



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Figure 10. Remote On/Off Implementation

Output Voltage Adjustment

Output voltage trim allows the user to increase or decrease the output voltage set point of a module. This is accomplished by connecting an external resistor between the TRIM pin and either the Vo(+) or Vo(-) pins. With an external resistor between the TRIM and Vo(+) pins (Radj-down), the output voltage set point (Vo, adj) decreases. With an external resistor between the TRIM pin and Vo(-) pin (Radj-up), Vo,adj increases.

The following equations determine the required external resistor value to obtain an output voltage change of Δ %:

$$\mathsf{Radj\text{-}down} \ = \ \bigg[\frac{c \big[d \cdot (100 - \Delta\%) - 100 \big]}{\Delta\%} - b \bigg] k \Omega$$

$$Radj-up = \left[\frac{100a}{d \cdot \Delta\%} - b\right] k\Omega$$

Device	а	b	С	d	-5% Vo Radj-down	+5% Vo Radj-up
LC020A	4.02	16.90	2.01	2.0	19.3 kΩ	23.3 kΩ
LC020B	15.40	15.40	1.58	9.80	246.5 kΩ	16.0 kΩ
LC020C	21.50	16.90	1.76	12.24	356.3 kΩ	18.2 kΩ
LC020F	14.0	51.10	5.19	2.70	110.9 kΩ	52.8 kΩ

Feature Descriptions (continued)

Output Voltage Adjustment (continued)

The adjusted output voltage cannot exceed 110% of the nominal output voltage between the Vo(+) and Vo(-) terminal.

The modules have a fixed current-limit set point. Therefore, as the output voltage is adjusted down, the available output power is reduced. In addition, the minimum output current is a function of the output voltage. As the output voltage is adjusted down, the minimum required output current can increase.

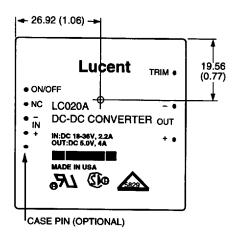
Synchronization (Optional)

The unit is capable of external synchronization from an independent time base with a switching rate of 256 kHz. The amplitude of the synchronizing pulse train is TTL compatible and the duty cycle ranges between 40% and 60%. Synchronization is referenced to Vin(+).

Thermal Considerations

Introduction

The LC020 power module operates in a variety of thermal environments; however, sufficient cooling should be provided to help ensure reliable operation of the unit. Heat-dissipating components inside the unit are thermally coupled to the case. Heat is removed by conduction, convection, and radiation to the surrounding environment. Proper cooling can be verified by measuring the case temperature. Peak case temperature (Tc) occurs at the position indicated in Figure 11.



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Note: Dimensions are in millimeters and (inches).

Figure 11. Case Temperature Measurement Location

Note that the view in Figure 11 is of the metal surface of the module—the pin locations shown are for reference. The temperature at this location should not exceed 100 °C. The output power of the module should not exceed the rated power for the module as listed in the Ordering Information table.

Heat Transfer Without Heat Sinks

Increasing airflow over the module enhances the heat transfer via convection. Figure 12 shows the maximum power that can be dissipated by the module without exceeding the maximum case temperature versus local ambient temperature (TA) for natural convection through 3.0 ms⁻¹ (600 ft./min.).

Thermal Considerations (continued)

Heat Transfer Without Heat Sinks (continued)

Note that the natural convection condition was measured at 0.05 ms⁻¹ (10 ft./min.) to 0.1 ms⁻¹ (20 ft./min.); however, systems in which these power modules may be used typically generate natural convection airflow rates of 0.3 ms⁻¹ (60 ft./min.) due to other heat dissipating components in the system. Use of Figure 12 is shown in the following example.

Example

What is the minimum airflow necessary for an LC020A operating at high line, an output current of 2.0 A, and a maximum ambient temperature of 83 °C?

Solution:

Given: $V_1 = 36 \text{ V}$, $I_0 = 2.0 \text{ A}$, $T_A = 83 \text{ °C}$ Determine PD (Figure 13): PD = 2.9 W Determine Airflow (Figure 12): $v = 1.0 \text{ ms}^{-1}$ (200 ft./min.)

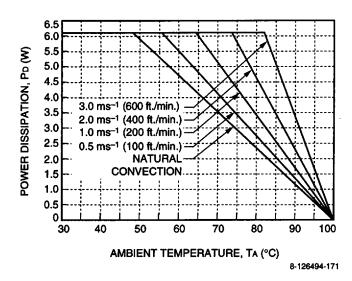


Figure 12. Forced Convection Power Derating with No Heat Sink; Either Orientation

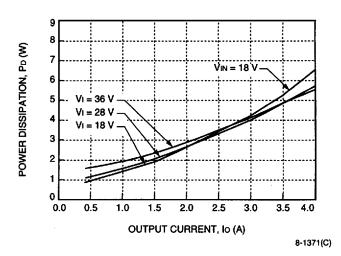
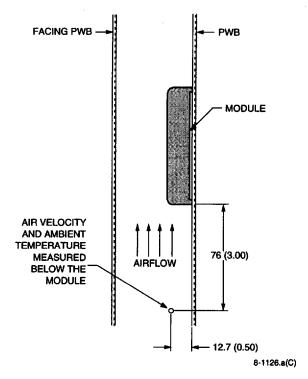


Figure 13. LC020A Power Dissipation vs. Output Current, Ta = 25 °C

Module Derating

The derating curves in Figure 12 were obtained from measurements obtained in an experimental apparatus shown in Figure 14. Note that the module and the printed-wiring board (PWB) that it is mounted on are vertically oriented. The passage has a rectangular cross section.



Note: Dimensions are in millimeters and (inches).

Figure 14. Experimental Test Setup

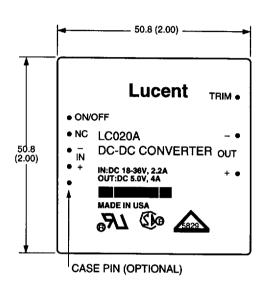
Outline Diagram

Dimensions are in millimeters and (inches). Copper paths must not be routed beneath the power module standoffs.

Tolerances: $x.x \pm 0.5$ mm (0.02 in.), $x.xx \pm 0.25$ mm (0.010 in.). Pin-to-pin tolerances are not cumulative.

Note: For standard modules, Vi(+) is internally connected to the case.

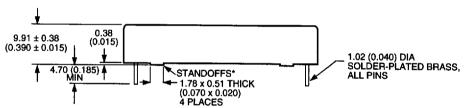
Top View



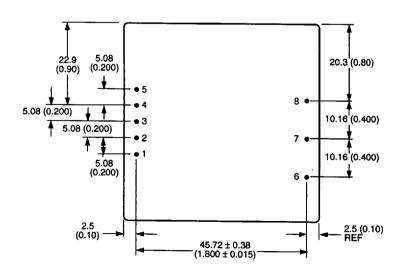
Pin	Function
1	Remote On/Off
2	No Connection (sync feature optional)
3	VI(-)/CASE [†]
4	VI(+)
5	Case Pin (pin optional) [†]
6	Trim
7	Output
8	+ Output

t Case is not connected to pin 3 if optional case pin 5 is specified.

Side View



Bottom View



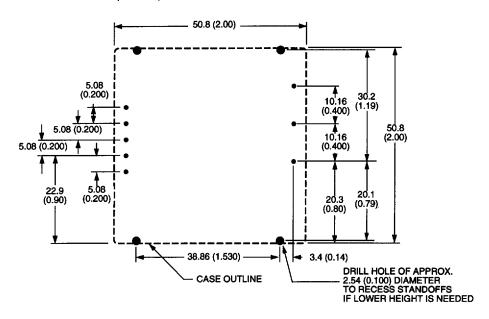
^{*} At the time this document was printed, standoffs were being added to the case.

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Recommended Hole Pattern

Component-side footprint.

Dimensions are in millimeters and (inches).



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Ordering Information

Input Voltage	Output Voltage	Output Power	Device Code	Comcode
28 V	3.3 V	13.2 W	LC020F	107681025
28 V	5 V	20 W	LC020A	107640815
28 V	12 V	20 W	LC020B	107681009
28 V	15 V	20 W	LC020C	107681017

Optional features may be ordered using the device code suffixes shown. To order more than one option, list suffixes in numerically descending order.

Please contact your Microelectronics Group Account Manager or Application Engineer for pricing and availability of options.

Option	Device Code Suffix
Short pin: 2.79 mm ± 0.25 mm (0.110 in. ± 0.010 in.)	8
Case ground pin	7
Synchronization	3
Negative logic on/off	1

For additional Information, contact your Microelectronics Group Account Manager or the following:

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